

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application)	<u>PATENT APPLICATION</u>
)	
Inventors:)	
Chung J. Lee)	
Hui Wang)	
Giovanni Antonio Foggato)	
)	
SC/Serial No.:)	
Unknown)	
)	
Filed:)	
Herewith)	
)	
Title:)	
LOW DIELECTRIC CONSTANT)	
MATERIALS PREPARED FROM)	
PHOTON OR PLASMA ASSISTED)	
CHEMICAL VAPOR DEPOSITION)	
AND TRANSPORT POLYMERIZATION)	
OF SELECTED COMPOUNDS)	
)	

DECLARATION FOR PATENT APPLICATION

As a below named inventor, I hereby declare that my residence, post office address and citizenship are as stated below next to my name; I believe that I am the first and joint inventor of the subject matter which is claimed and for which a patent is sought on the invention entitled:

**LOW DIELECTRIC CONSTANT MATERIALS PREPARED FROM
PHOTON OR PLASMA ASSISTED CHEMICAL VAPOR DEPOSITION
AND TRANSPORT POLYMERIZATION OF SELECTED COMPOUNDS**

the specification of which (check applicable ones):

 X is filed herewith;

 was filed with the above-identified "Filed" date and "SC/Serial No."

 was amended on (or amended through) .

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment(s) referred to above. I acknowledge the duty to disclose information which is material to the examination of the application in accordance with Title 37, Code of Federal Regulations, §1.56.

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true, and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under §1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

(1) Full name of sole
or first inventor: Chung J. Lee

(1) Residence: 1673 Oro Drive
Fremont, CA 94539

(1) Post Office Address: Same as above

(1) Citizenship: United States

(1) Inventor's signature: Chung J. Lee

(1) Date: Oct. 23, 1997

(2) Full name of second
joint inventor: Hui Wang

(2) Residence: 38855 Litchfield Circle
Fremont, California 94536

(2) Post Office Address: Same as above

(2) Citizenship: P.R. China

(2) Inventor's signature: Hui Wang

(2) Date: Oct. 23, 1997

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true, and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under §1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

(3) Full name of third
joint inventor: Giovanni Antonio Foggato

(3) Residence: 16340 Oakwood Lane
Morgan Hill, California 95037

(3) Post Office Address: Same as above

(3) Citizenship: United States

(3) Inventor's signature: Giovanni Antonio Foggato

(3) Date: 10/23/97